

23105 Kashiwa Court, Torrance, CA 90505 Phone: (800) 579-4875 or (310) 534-1505 Fax: (310) 534-1424 E-mail: webmaster@ledtronics.com Website: http://www.ledtronics.com

## **SML080CWR5B-011**

<u>Hi-Eff Red</u> Axial Surface Mount LEDs 2.1×2.2×2.7mm, Z-bend leads 35° viewing angle

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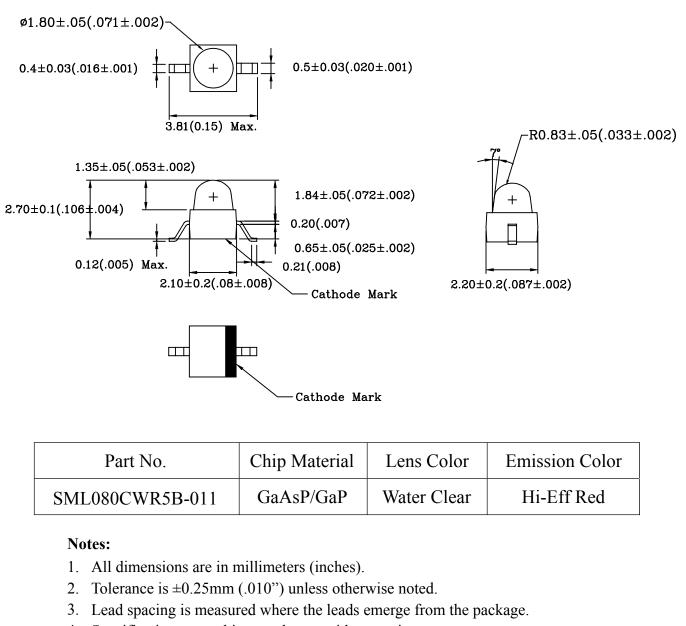
# LED<sup>®</sup> LEDTRONICS, INC.®

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### **Features:**

- High intensity
- Axial type
- "Z-bend" leads

### **Package Dimensions:**



4. Specifications are subject to change without notice.

SML080CWR5B-011

Part No.

DWG NO. DSTR0235



LEDTRONICS, INC.®

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### Electrical and optical characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =20mA	-	2.0	2.6	V
Luminous Intensity	lv	I <sub>F</sub> =20mA	-	55	-	mcd
Peak Wave Length	λρ	I <sub>F</sub> =20mA	639	642	646	nm
Dominant Wave Length	λd	I <sub>F</sub> =20mA	623	626	630	nm
Spectral Line Half-width	Δλ	I <sub>F</sub> =20mA	-	43	-	nm
Viewing Angle*	2θ <sub>1/2</sub>	I <sub>F</sub> =20mA	-	35	-	deg
Radiant Intensity	le	I <sub>F</sub> =20mA	-	-	-	µW/sr
Chromaticity Coordinates	Х	l <sub>⊧</sub> =20mA	-	0.70	-	
	Y	1- 2011/1	-	0.29	-	

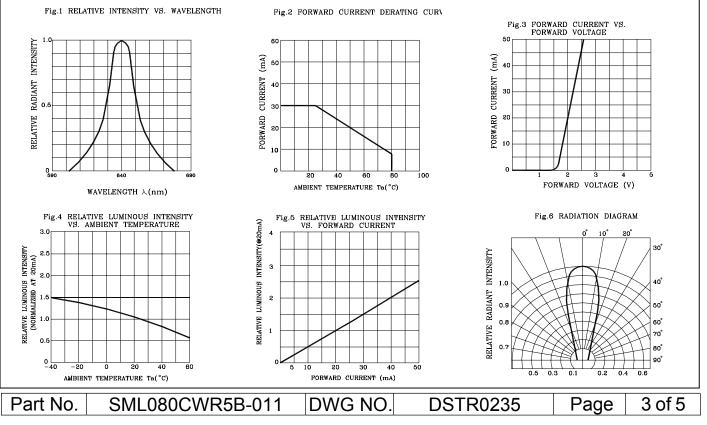
\* Viewing angle is the Off-axis at which the luminous intensity is half the axial intensity.

\* This product is RoHS compliant.

### Absolute Maximum Ratings (Ta=25°C)

Reverse Voltage	V <sub>R</sub>	5V		
Reverse Current (VR=5V)	I <sub>R</sub>	100µA		
Continuous Forward Current	lf	30mA		
Peak Forward Current 1/10 duty cycle, 0.1ms Pulse Width	Peak If	100mA		
Power Dissipation	Pd	80mW		
Operating Temperature Range Topr		-25°C ~ 80°C		
Storage Temperature Range		100°C ~ 150°C Within 2 Minutes		
Lead Soldering Temperature		240°C ~ 250°C Within 5 Seconds		

### **Typical Electro-Optical Characteristics Curves**

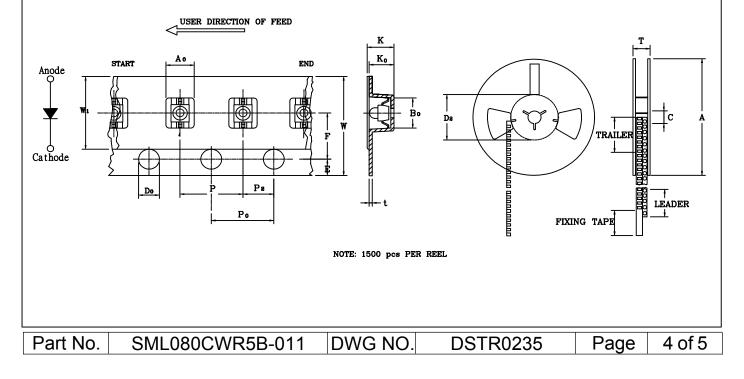


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### Taping specifications (Units: mm)

		SPECIFICATION			
ITEM	SYMBOL	Minimum		Maximum	
		mm	inch	mm	inch
Tape Feed Hole Diameter (DIA)	$D_0$	1.40	0.055	1.55	0.061
Feed Hole Location	Е	1.65	0.065	1.85	0.072
Centers Line Dimensions Length Direction	F	5.45	0.215	5.55	0.218
Compartment Depth	K <sub>0</sub>	3.10	0.122	3.30	0.130
Carrier Tape Overall Thickness	K	3.00	0.118	3.20	0.126
Compartment Pitch	Р	3.90	0.153	4.10	0.161
Sprocket Hole Diameter	P <sub>0</sub>	3.90	0.153	4.10	0.161
Centers Line Dimensions Length Direction	P <sub>2</sub>	1.95	0.076	2.05	0.080
Carrier Tape Thickness	t	_	-	0.30	0.012
Carrier Tape Width	W	12.00	0.472	12.30	0.484
Flange Diameter	А	178.0	7.008	180.0	7.087
Hub Spindle Hole	С	12.50	0.492	13.50	0.531
Hub Diameter	D <sub>2</sub>	20.00	0.788	21.50	0.846
Fixing Tape Width	W1	9.00	0.354	9.30	0.366
Flange Space Between Flanges	Т	16.00	0.629	17.00	0.669
Compartment Length	A <sub>0</sub>	2.20	0.087	2.40	0.094
Compartment Width	B <sub>0</sub>	3.90	0.154	4.10	0.161



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### DEI IABII ITV TEST

Classification	Test Item	Reference Standard	Test Conditions	Result
	Operation Life	MIL-STD-750: 1026 MIL-STD-883: 1005 JIS C 7021: B-1	Connect with a power I = $20\text{mAf}$ T <sub>a</sub> = Under room temperature Test time = 1,000hrs	0/20
Endurance Test	High Temperature, High Humidity Storage	MIL-STD-202: 103B JIS C 7021: B-11	T <sub>a</sub> = +65°C±5°C RH = 90%-95% Test time = 240hrs	0/20
	High TemperatureMIL-STD-883: 1008High $T_a = +85^{\circ}C\pm5^{\circ}C$ StorageJIS C 7021: B-10Test time = 1,000hrs			0/20
	Low Temperature Storage	JIS C 7021: B-12	Low T <sub>a</sub> = -35°C±5°C Test time = 1,000hrs	0/20
Environmental Test	Temperature Cycling	MIL-STD-202: 107D MIL-STD-750: 1051 MIL-STD-883: 1010 JIS C 7021: A-4	-35°C ~ +25°C ~ +85°C ~ +25°C 60min. 20min. 60min. 20min. Test time = 5 cycles	0/20
	Thermal Shock	MIL-STD-202: 107D MIL-STD-750: 1051 MIL-STD-883: 1011	-35°C±5°C ~ +85°C±5°C 20min. 20min. Test time = 10 cycles	0/20
	Solder Resistance	MIL-STD-202: 201A MIL-STD-750: 2031 JIS C 7021: A-1	Preheating: 140°C - 160°C, within 2 minutes. Operation heating: 235°C (Max.), within 10 seconds. (Max.)	0/20

### JUDGEMENT CRITERIA OF FAILURE FOR THE RELIABILITY TEST

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V <sub>f</sub> (V)	l f = 20mA	Over Ux1.2
Reverse current	۱ <sub>۲</sub> (uA)	$V_{\Gamma} = 5V$	Over Ux2
Luminous intensity	I <sub>V</sub> (mcd)	I f = 20mA	Below Sx0.5

Note: 1. U means the upper limit of specific characteristics. S means initial value.

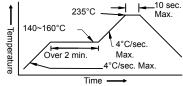
2. Measurement shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.

### 1. Soldering

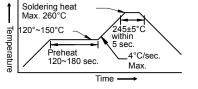
Manual of Soldering The temperature of the iron tip should not be higher than 300°C (572°F) and soldering within 3 seconds per

solder-land is to be observed.

Reflow Soldering Preheating: 140°C-160°C ±5°C, within 2 minutes. Operation heating: 235°C (Max.) within 10 seconds. (Max.) Gradual Cooling (Avoid quenching).



DIP Soldering (Wave Soldering) Preheating: 120°C~150°C, within 120~180 sec. Operation heating: 245°C ±5°C within 5 sec. 260°C (Max.) Gradual Cooling (Avoid quenching).



### 2. Handling

Care must be taken not to cause damage to the epoxy resin portion of LEDs while it is exposed to high temperatures, or abrade the epoxy resin portion of LEDs with hard or sharp items as from sand blasting and use of pointed objects.

#### 3. Notes for designing

Care must be taken to provide the current limiting resistor in the circuit so as to drive the LEDs within the rated figures. Also, caution should be taken not to overload LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be designed so as to be subjected to reverse voltage when turning off the LEDs.

#### 4. Storage:

In order to avoid the absorption of moisture, it is recommended to solder LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, store it in the following environment:

(1) Temperature: 5°C-30°C (41°F-86°F) Humidity: RH 60% Max.

(2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent

soldering process must be:

a. Completed within 24 hours.

- b. Stored at less than 30% RH
- (3) Devices require baking before mounting if: (2)a or (2)b is not met.
- (4) If baking is required, devices must be baked under below conditions: 12 hours at 60°C ±3°C

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